



AMENDMENT TRANSMITTAL LETTER						Docket No. 0171-1022P	
Application No. 10/671,732-Conf. #6775		Filing Date September 29, 2003		Examiner S. J. Lee		Art Unit 1752	
Applicant(s): Takeshi KINSHO et al.							
				IPOUND, MANUFA ERNING PROCES		S METHOD,	
MS Amendment Commissioner for I P.O. Box 1450 Alexandria, VA 223 Transmitted here The fee has beer	313-1450 with is an ame			• •			
CLAIMS AS AMENDED							
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate			
Total Claims	16	- 20 =		x			
Independent Claims	7	- 7 =		x			
Multiple Dependent Claims (check if applicable)							
Other fee (please specify):							
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:						0.00	
x Large Entity Small Entity							
x No additional fee is required for this amendment.							
Please charge Deposit Account No in the amount of \$  A duplicate copy of this sheet is enclosed.							
A check in the amount of \$ is enclosed.							
Payment by credit card. Form PTO-2038 is attached.							
The Director is hereby authorized to charge and credit Deposit Account No02-2448 as described below. A duplicate copy of this sheet is enclosed.							
x Credit any overpayment.							
x Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.							
Dated: April 24, 2006							
Andrew 29 Meil Attorney Reg. I							
BIRCH, STEW 8110 Gatehous Suite 100 East P.O. Box 747 Falls Church, V (703) 205-8000	se Road ⁄irginia 22040-		LP				
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Docket No.: 0171-1022P

(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Takeshi KINSHO et al.

Application No.: 10/671,732

Confirmation No.: 6775

Filed: September 29, 2003

Art Unit: 1752

For: POLYMERIZABLE SILICON-CONTAINING

COMPOUND, MANUFACTURING METHOD, POLYMER, RESIST COMPOSITION AND

**PATTERNING PROCESS** 

Examiner: S. J. Lee

## **AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

## **INTRODUCTORY COMMENTS**

In response to the Office Action dated January 24, 2006, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 11 of this paper.